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10/672,013	09/26/2003	Seong Deok Ahn	2013P107	7684
8791 7590 12/10/2007 BLAKELY SOKOLOFF TAYLOR & ZAFMAN 1279 OAKMEAD PARKWAY			EXAMINER	
			BUEKER, RICHARD R	
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Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

	Application No.	Applicant(s)				
	10/672,013	AHN ET AL.				
Office Action Summary	Examiner	Art Unit				
	Richard Bueker	1792				
- The MAILING DATE of this communication appears on the cover sheet with the correspondence address Period for Reply						
A SHORTENED STATUTORY PERIOD FOR REPL' WHICHEVER IS LONGER, FROM THE MAILING D. Extensions of time may be available under the provisions of 37 CFR 1.1 after SIX (6) MONTHS from the mailing date of this communication. If NO period for reply is specified above, the maximum statutory period of Failure to reply within the set or extended period for reply will, by statute Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	ATE OF THIS COMMUNICATION 36(a). In no event, however, may a reply be timwill apply and will expire SIX (6) MONTHS from a cause the application to become ABANDONE	N. nely filed the mailing date of this communication. D (35 U.S.C. § 133).				
Status						
Responsive to communication(s) filed on <u>03 O</u> This action is FINAL . 2b) ☐ This 3)☐ Since this application is in condition for allowed closed in accordance with the practice under E	action is non-final.					
Disposition of Claims						
4) ⊠ Claim(s) 1,2,4,6 and 8-14 is/are pending in the 4a) Of the above claim(s) is/are withdray 5) □ Claim(s) is/are allowed. 6) ⊠ Claim(s) 1,2,4,6 and 8-14 is/are rejected. 7) □ Claim(s) is/are objected to. 8) □ Claim(s) are subject to restriction and/or	wn from consideration.					
Application Papers						
9) The specification is objected to by the Examine 10) The drawing(s) filed on is/are: a) acc Applicant may not request that any objection to the Replacement drawing sheet(s) including the correct 11) The oath or declaration is objected to by the Examine 11.	epted or b) objected to by the I drawing(s) be held in abeyance. See tion is required if the drawing(s) is obj	e 37 CFR 1.85(a). jected to. See 37 CFR 1.121(d).				
Priority under 35 U.S.C. § 119	•					
 12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f). a) All b) Some * c) None of: 1. Certified copies of the priority documents have been received. 2. Certified copies of the priority documents have been received in Application No. 3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)). * See the attached detailed Office action for a list of the certified copies not received. 						
Attachment(s)						
1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO/SB/08) Paper No(s)/Mail Date 8/9/07.	4) Interview Summary Paper No(s)/Mail Da 5) Notice of Informal P 6) Other:	nte				

Claims 11-14 are rejected under 35 U.S.C. 112, first paragraph, as failing to comply with the written description requirement. The claim(s) contains subject matter which was not described in the specification in such a way as to reasonably convey to one skilled in the relevant art that the inventor(s), at the time the application was filed, had possession of the claimed invention. In claim 11, lines 5-8, the phrase "transferring the first organic source vapors by a transfer gas supplied from a transfer gas supply source via a transfer gas transfer line, which is maintained at a constant temperature to prevent condensation of the first organic source vapors" appears to be new matter. Applicants are respectfully requested to point out where in their specification the support for this limitation is located. If the recited "transfer gas transfer line" is intended to be line 417 of applicants' Fig. 2, then it is noted that Fig. 2 does not include a heater on line 417. Also, it is unclear where the specification provides description of maintaining transfer gas transfer line 417 "at a constant temperature to prevent condensation of the first organic source vapors".

Claims 11-14 are rejected under 35 U.S.C. 112, second paragraph, as being indefinite for failing to particularly point out and distinctly claim the subject matter which applicant regards as the invention. In claim 11, lines 5-8, the phrase "transferring the first organic source vapors by a transfer gas supplied from a transfer gas supply source via a transfer gas transfer line, which is maintained at a constant temperature to prevent condensation of the first organic source vapors" is unclear. Applicants are respectfully requested to point out each element number of their drawings that correspond to each element recited in the above quoted passage.

Claims 1, 4, 6, 8 and 9 are rejected under 35 U.S.C. 103(a) as being unpatentable over Nishikawa (6,277,201) taken in view of Randive (6,789,789) and/or Ono (JP 2001-011634) and optionally taken in further view of Simhan (3,888,649).

Nishikawa (see Fig. 1, for example) discloses an apparatus for vapor phase deposition including a process chamber, a temperature controlled substrate holder, a showerhead, a source chamber for generating organic source vapors, and a diluted gas supply (see line L5 of Fig. 1, col. 2, lines 50-54, col. 4, lines 7-20 and col. 5, lines 58-63). The source chamber of Nishikawa doesn't include a conic block or conic plate transfer gas distributor of the type now claimed. Each of Randive (see Fig. 4, for example) and Ono (see Figs. 1-6, for example), however, discloses an alternative type of vaporizer for vaporizing an organo-metallic CVD precursor liquid, wherein the vaporizer source chamber includes a transfer gas distributor in the form of "a conic block or conic plate with an apex aligned with a transfer gas inlet and pointing towards the transfer gas inlet and is formed such that the transfer gas cannot be transmitted therethrough in order to distribute widely along an outer inclined plane of the conic block or conic plate the transfer gas from the transfer gas inlet" as now recited in claim 1. It would have been prima facie obvious to one skilled in the art to modify the apparatus of Nishikawa by replacing Niskikawa's vaporizer with a functionally equivalent vaporizer of the type described by Randive or Ono, as the results of such a substitution would be no more than expected by one skilled in the art.

Claim 1 has been newly amended to add the limitations of (1) the transfer gas inlet being formed by a first plurality of holes, and (2) the source vapor outlet formed by

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a second plurality of holes. Regarding these limitations, it is noted that in Randive's apparatus (see Fig. 4), the porous plate 74 is a transfer gas inlet as claimed and it is formed of a first plurality of holes for allowing transfer gas to enter the source chamber for distribution by the transfer gas distributor. Also, the source vapor outlet includes a plurality of gaps 90 as described at col. 5, lines 51-55 of Randive. The dictionary definition of "hole" includes "gap", and the plurality of gaps 90 of Randive are a plurality of holes that form the source vapor outlet. Also, Simhan (see Fig. 1, elements 34 and 35) is cited as an alternative example of using a plurality of holes to form a source vapor outlet under a splash cone. It would have been obvious to form the source vapor outlet that supports the splash guard of Randive as a plurality of round holes in the manner taught by Simhan, because Simhan teaches that a such a vapor outlet having round holes can successfully be used for the desired purpose of Randive. Also, regarding Ono, Ono (see Figs. 3 and 4 and paragraph 45) teaches that his transfer gas inlet is formed of many carrier gas blow holes 8. Also, it would have been obvious to modify the source vapor outlet of Ono by providing it with gap holes as taught by Randive, or round holes as taught by Simhan, because each of Randive and Simhan teach that a plurality of holes provided in a source vapor outlet will successfully perform the desired function of Ono of removing source gas from a vaporizing chamber.

Regarding claim 6, the source heater of each of Randive and Ono also surrounds the organic source vapor outlet. Regarding claim 9, Nishikawa's apparatus includes a plurality of transfer lines and valves connected to line L5 as recited in claim 9.

Claim 2 is rejected under 35 U.S.C. 103(a) as being unpatentable over
Nishikawa (6,277,201) taken in view of Randive (6,789,789) and/or Ono (JP 2001011634) and optionally in further view of Simhan (3,888,649) for the reasons discussed above, and taken in further view of Ohashi (6,059,885) (see Figs. 2-10, and col. 14, lines 59-60, for example) or Nguyen (6,444,039) (see Figs. 2 and 6 and col. 2, lines 815, for example), each of whom teaches the use of a shower curtain installed between a shower head and a substrate holder in a vapor deposition apparatus, wherein the shower curtain surrounds the substrate holder to improve the gas flow or protect the process chamber walls, and for those reasons it would have been obvious to use such a shower curtain in the vapor deposition apparatus of Nishikawa.

Claims 6, 11 and 12 are rejected under 35 U.S.C. 103(a) as being unpatentable over Nishikawa (6,277,201) taken in view of Randive (6,789,789) and/or Ono (JP 2001-011634) and optionally taken in further view of Simhan (3,888,649) for the reasons stated above, and taken in further view of Van Buskirk (5,882,416). Van Buskirk (see Figs. 1 and 6 and col. 10, lines 25-62, particularly lines 58-62) teaches that a source vapor transfer line that transfers source vapor from a vaporizer to a CVD chamber should be kept at a constant temperature to prevent condensation. It would have been obvious to one skilled in the art to maintain the source vapor transfer line L3 of Nishikawa at a constant temperature because Van Buskirk teaches that it is desirable to do so. Regarding the step of purging recited in claim11, it is noted that Nishikawa (see Fig. 1 and col. 6, lines 5-9) teaches the step of purging a CVD chamber after a thin film formation process has been completed.

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Claims 1, 9 and 11-14 are rejected under 35 U.S.C. 103(a) as being unpatentable over Campbell (6,461,436) taken in view of Gordon (6,969,539) and in further view of Randive (6,789,789) and/or Ono (JP 2001-011634) and optionally in further view of Simhan (3,888,649), and in further view of Chiang (6,630,201) or Aro (WO 01/40541). Campbell discloses an atomic layer deposition (ALD) apparatus and method. ALD is a type of vapor phase deposition that can use an organo-metallic coating material, and therefore ALD can be a "a method using organic vapor phase deposition" as presently claimed. The apparatus of Campbell (see Fig. 4, for example) includes a process chamber 10, a substrate holder and temperature controller 13, a showerhead 18, a plurality of transfer lines 6, 9,26 and 36 which are installed to allow different organic vapors to sequentially enter the process chamber or bypass the chamber using "time-division", and a plurality of valves 4 and 8, as presently claimed. Campbell doesn't discuss specific organo-metallic compounds used in his apparatus, or the types of vaporizers used to supply the compounds. Gordon (see Fig. 1, for example) also discloses ALD processes and apparatus, and he teaches the use of plural organo-metallic compounds as source materials to be vaporized for use in an ALD process. Gordon also teaches (see col. 20, lines 13-33, for example) that any conventional vaporizer can be used to vaporize the liquid organo-metallic compounds in order to provide plural flows of vapor to be supplied to the ALD process chamber. Gordon specifically suggests vaporizers such as thin film evaporators or direct liquid injection vaporizers, which are the type of vaporizers that are described by Randive, Takamatsu and Ono. It would have been obvious to one skilled in the art to use two

organo-metallic source vaporizers of the type taught by Randive, Takamatsu or Ono as the ALD material sources in the apparatus of Campbell, because Gordon teaches that it is desirable to use two organo-metallic source materials for ALD, and because Gordon specifically teaches that vaporizers of the type taught by Randive, Takamatsu or Ono can successfully be used for ALD. Gordon (see Fig. 1 and the paragraph bridging cols. 21 and 22) also teaches that a vapor transfer line should be kept at a constant temperature to prevent condensation, as recited in claim 11. Also, Chiang and Aro are cited in the rejection for their more detailed explanation of the ALD process. Chiang (see Figs. 21, 22, 35(a)-35(d), 39(a) and 39(b), for example) and Aro (see page 2, lines 15-33) explain that an ALD process inherently includes a step of forming an organic containing thin film on the substrate by chemisorption, and this step is inherent in any ALD process using organo-metallic compounds. Simhan is optionally cited for the same reasons as discussed in the first prior art rejection above.

Claim 10 is rejected under 35 U.S.C. 103(a) as being unpatentable over Campbell (6,461,436) taken in view of Gordon (6,969,539) and in further view of Randive (6,789,789) and/or Ono (JP 2001-011634) and optionally in further view of Simhan (3,888,649) and in further view of Chiang (6,630,201) or Aro (WO 01/40541) for the reasons stated it the previous paragraph rejection, and taken in further view of Van Buskirk (5,882,416). Van Buskirk (see Figs. 1 and 6 and col. 10, lines 25-62, particularly lines 58-62) teaches that a source vapor transfer line that transfers source vapor from a vaporizer to a CVD chamber should be kept at a constant temperature to prevent condensation. Van Buskirk also teaches that a bypass vent line (line 134 of

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Fig. 1) should be kept at a constant temperature to prevent condensation. It would have been obvious to one skilled in the art to maintain the source vapor transfer lines of Campbell, including the bypass vent lines 26 and 36, at a constant temperature because Van Buskirk teaches that it is desirable to do so.

Applicants have argued that the none of the cited prior art references teach the newly claimed limitations of "the transfer gas inlet formed by a first plurality of holes . . . to allow the transfer gas to enter the source chamber" and "the organic source vapor outlet formed by a second plurality of holes . . . to allow the organic source vapors. . . to exit the source chamber". Regarding these limitations, it is noted that in Randive's apparatus (see Fig. 4), the porous plate 74 is a transfer gas inlet as claimed and it is formed of a first plurality of holes for allowing transfer gas to enter the source chamber for distribution by the transfer gas distributor. Also, the source vapor outlet includes a plurality of gaps 90 as described at col. 5, lines 51-55 of Randive. The dictionary definition of "hole" includes "gap", and the plurality of gaps 90 of Randive are a plurality of holes that form the source vapor outlet. Also, Simhan (see Fig. 1, elements 34 and 35) has been cited as an alternative example of using a plurality of holes to form a source vapor outlet under a splash cone. It would have been obvious to form the source vapor outlet that supports the splash guard of Randive as a plurality of round holes in the manner taught by Simhan, because Simhan teaches that a such a vapor outlet having round holes can successfully be used for the desired purpose of Randive. Also, regarding Ono, Ono (see Figs. 3 and 4 and paragraph 45) teaches that his transfer gas inlet is formed of many carrier gas blow holes 8. Also, it would have been

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obvious to modify the source vapor outlet of Ono by providing it with gap holes as taught by Randive, or round holes as taught by Simhan, because each of Randive and Simhan teach that a plurality of holes provided in a source vapor outlet will successfully perform the desired function of Ono of removing source gas from a vaporizing chamber.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Richard Bueker whose telephone number is (571) 272-1431. The examiner can normally be reached on 9 AM - 5:30 PM, Monday-Friday.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Parviz Hassanzadeh can be reached on (571) 272-1435. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

Richa Bul

Richard Bueker Primary Examiner